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Passive RF and microwave devices, intermodulation level measurement -Part 2: Measurement of passive infermodulation in coaxial cable assemblies





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

PASSIVE RF AND MICROWAVE DEVICES, INTERMODULATION LEVEL MEASUREMENT –

Part 2: Measurement of passive intermodulation in coaxial cable assemblies

FOREWORD

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International Standard IEC 62037-2 has been prepared by technical committee 46: Cables, wires, waveguides, r.f. connectors, r.f. and microwave passive components and accessories.

The text of this standard is based on the following documents:

FDIS	Report on voting
46/408/FDIS	46/420/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts in the IEC 62037 series, published under the general title *Passive RF and microwave devices*, *Intermodulation level measurement* can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn
- · replaced by a revised edition, or
- amended.

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PASSIVE RF AND MICROWAVE DEVICES, INTERMODULATION LEVEL MEASUREMENT -

Part 2: Measurement of passive intermodulation in coaxial cable assemblies

1 Scope

This part of IEC 62037 defines a procedure to measure levels of passive intermodulation generated by a coaxial cable assembly.

This test method is applicable to jumper cables, i.e. cable assemblies intended to provide interface flexibility between rigid devices.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62037-1:2012, Passive RF and microwave devices, intermodulation level measurement – Part 1: General requirements and measuring methods

3 Abbreviations

DUT Device under test

PIM Passive intermodulation

4 Test set-up

Set-up 1 and set-up 2 are applicable in this PIM-test. Either set-up 1 (reverse method, see 6.2.2 of IEC 62037-1:2012), or set-up 2 (forward method, see 6.2.3 of IEC 62037-1:2012), may be used for cable assemblies, provided that the attenuation of the assembly is not greater than 1 dB. For higher attenuation, the reverse method shall be used.

The connector under test should be clamped and mechanically secured to prevent its movement during the test.

A describable and repeatable mechanical stress is applied to the DUT. This mechanical stress is defined by a distance d, between the end of the cable-entry (the last rigid mechanical point of the connector) and the point of the deflection, and circular movement around the cable axis with a radius r. This test shall be performed on each end independently. An example of a test set-up is shown in Figure 1. The cable movement is depicted in Figure 2. The rotational radius (r) and distance (d) is defined in Table 1. The cable attachment to the termination should be supported.